APPROVAL SHEET

WF10H

±0.1%, ±0.5%

High Precision chip resistors

Size 1210

*Contents in this sheet are subject to change without prior notice.

FEATURE

1. High reliability and stability
2. Reduced size of final equipment
3. Lower assembly costs
4. Higher component and equipment reliability
5. RoHS compliant and Lead free products

APPLICATION

- Consumer electrical equipment
- Automotive application
- EDP, Computer application
- Telecom application

DESCRIPTION

The resistors are constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to nominated value within tolerance which controlled by laser trimming of this resistive layer.

The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a Tin (lead free) alloy.

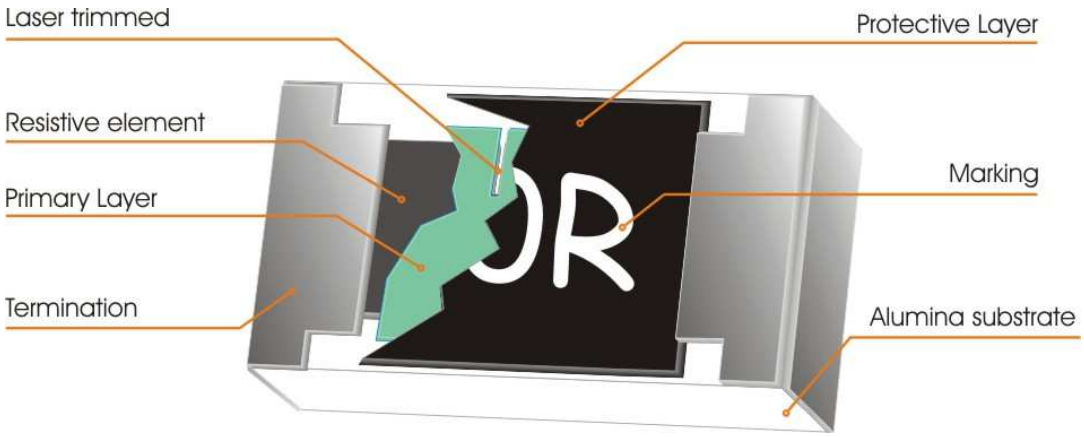


Fig 1. Consctruction of Chip-R

QUICK REFERENCE DATA

Item	General Specification
Series No.	**WF10H**
Size code	**1210 (3226)**
Resistance Tolerance	**±0.1% , ±0.5% (E96+E-24)**
Resistance Range	**10Ω ~ 1MΩ (E96+E24 series)**
TCR (ppm/°C) -55°C ~ +155°C	**≤ ± 100 ppm/°C**
Max. dissipation at T_{amb}=70°C	**1/3 W**
Max. Operation Voltage (DC or RMS)	**200V**
Max. Overload Voltage (DC or RMS)	**400V**
Climatic category (IEC 60068)	**55/155/56**
Basic specification	**JIS C 5201-1 : 1998**

Note :

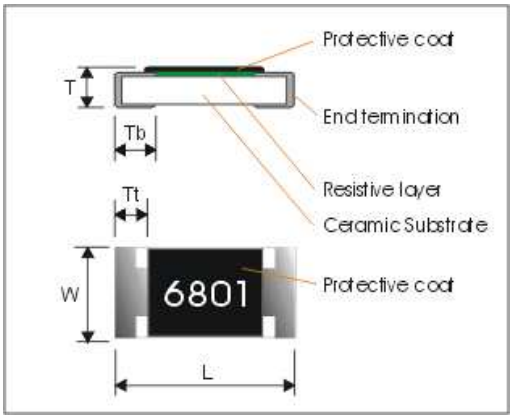
1. This is the maximum voltage that may be continuously supplied to the resistor element, see “IEC publication 60115-8”

2. Max. Operation Voltage : So called RCWV (Rated Continuous Working Voltage) is determined by

$$RCWV = \sqrt{Rated\,Power \times Resistance\,Value}$$ or Max. RCWV listed above, whichever is lower.

DIMENSIONS(unit : mm)

Part No	WF10H
L	**3.10 ± 0.10**
W	**2.60 ± 0.10**
Tt	**0.50 ± 0.20**
Tb	**0.50 ± 0.20**
t	**0.55 ± 0.10**



MARKING

4-digits marking for 0.1%, 0.5%

RESISTANCE	90Ω	100Ω	6800Ω	47000Ω
4-digits marking	90R0	1000	6801	4702

FUNCTIONAL DESCRIPTION

Product characterization

Standard values of nominal resistance are taken from the E96 & E24 series for resistors with a tolerance of ±0.1%, ±0.5%. The values of the E24/E96 series are in accordance with “IEC publication 60063”.

Derating

The power that the resistor can dissipate depends on the operating temperature; see Fig.2

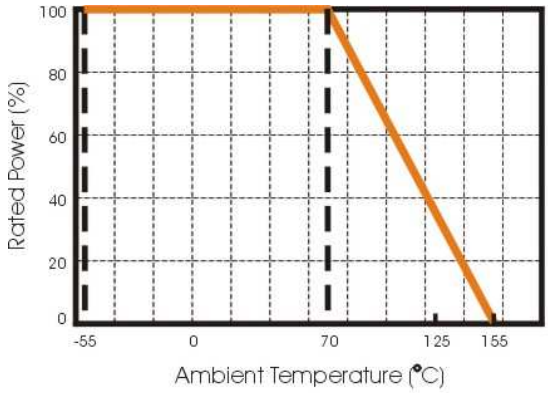


Figure 2. Maximum dissipation in percentage of rated power

As a function of the ambient temperature

MOUNTING

Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems. Chip placement can be on ceramic substrates and printed-circuit boards (PCBs). Electrical connection to the circuit is by individual soldering condition. The end terminations guarantee a reliable contact.

SOLDERING CONDITION

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 235°C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 3.

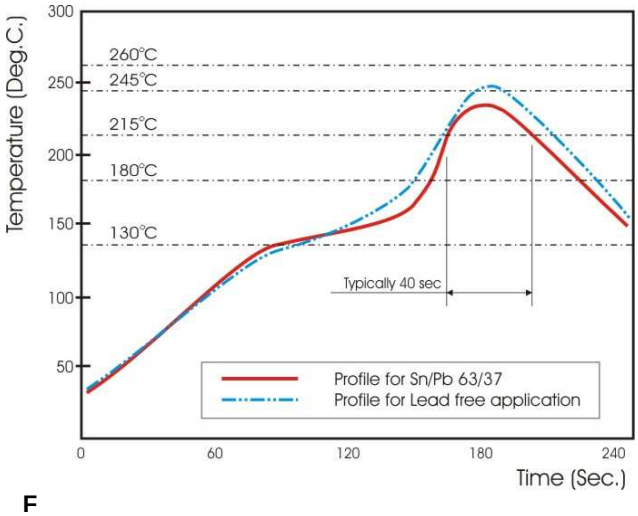


Fig 3. Infrared soldering profile for Chip Resistors

CATALOGUE NUMBERS

The resistors have a catalogue number starting with .

WF10	H	4702	D	T	L
Size code **WF10: 1210**	**Type code** **H** : High precision, <1%, TCR>50ppm	**Resistance code** E96 +E24: 3 significant digits followed by no. of zeros 102Ω =1020 37.4KΩ =3742 220Ω =2200	**Tolerance** **D : ± 0.5%** **B : ± 0.1%**	**Packaging code** **T:** 7" Reeled taping	**Termination code** **L** = Sn base (lead free)

■ **Reeled tape packaging : 8mm width paper taping 5000pcs per 7" reel.**

TEST AND REQUIREMENTS(JIS C 5201-1 : 1998)

Basic specification : JIS C 5202 / IEC 60115-1

The tests are carried out in accordance with IEC publication 68, "Recommended basic climatic and mechanical robustness testing procedure for electronic components" and under standard atmospheric conditions according to IEC 68-1, subclause 5.3, unless otherwise specified.

Temperature: 15ºC to 35ºC.

Relative humidity: 45% to 75%.

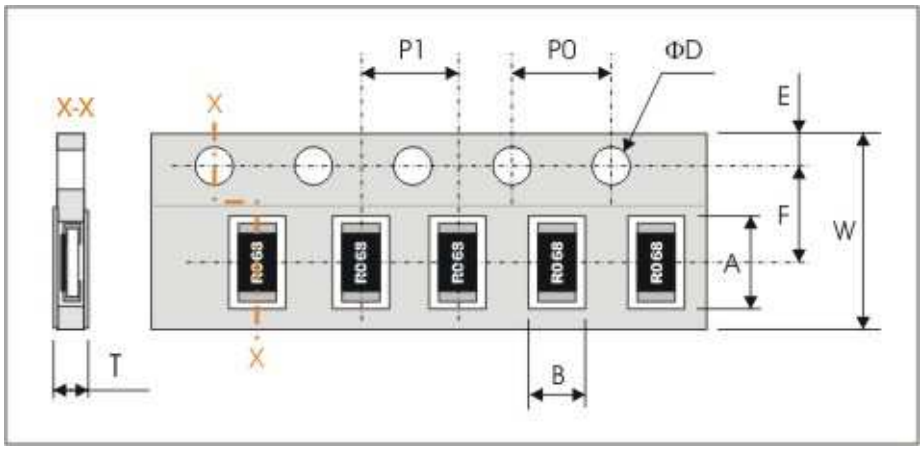
Air pressure: 86kPa to 106 kPa (860 mbar to 1060 mbar).

TEST	PROCEDURE	REQUIREMENT
Temperature Coefficient of Resistance(T.C.R) **Clause 4.8**	Natural resistance change per change in degree centigrade. $\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6$ (ppm/°C) t_1 : 20℃+5℃-1℃ R_1 : Resistance at reference temperature R_2 : Resistance at test temperature	Refer to "QUICK REFERENCE DATA"
Short time overload (S.T.O.L) **Clause 4.13**	Permanent resistance change after a 5second application of a voltage 2.5 times RCWV or the maximum overload voltage specified in the above list, whichever is less.	ΔR/R max. ±(2%+0.1Ω)
Resistance to soldering heat(R.S.H) **Clause 4.18**	Un-mounted chips completely immersed for 10±1second in a SAC solder bath at 260℃±5°C	no visible damage Δ R/R max. ±(1%+0.05Ω)
Solderability **Clause 4.17**	Un-mounted chips completely immersed for 2±0.5second in a solder bath at 235℃±5℃	good tinning (>95% covered) no visible damage
Temperature cycling **Clause 4.19**	30 minutes at -55°C±3°C, 2~3 minutes at 20℃+5℃-1℃, 30 minutes at +155°C±3°C, 2~3 minutes at 20℃+5℃-1℃, total 5 continuous cycles	no visible damage ΔR/R max. ±(1%+0.05Ω)

TEST	PROCEDURE	REQUIREMENT
Load life (endurance) **Clause 4.25**	70±2°C, 1000 hours, loaded with RCWV or Vmax,1.5 hours on and 0.5 hours off	ΔR/R max. ± (3%+0.1Ω)
Load life in Humidity **Clause 4.24**	1000 hours, at rated continuous working voltage in humidity chamber controller at 40°C±2°C and 90~95% relative humidity, 1.5hours on and 0.5 hours off	ΔR/R max. ± (3%+0.1Ω)
Bending strength **Clause 4.33**	Resistors mounted on a 90mm glass epoxy resin PCB(FR4); bending : 3 mm, once for 10 seconds	ΔR/R max. ±(1%+0.05Ω)
Adhesion **Clause 4.32**	Pressurizing force: 5N, Test time: 10±1sec.	No remarkable damage or removal of the terminations
Insulation Resistance **Clause 4.6**	Apply the maximum overload voltage (DC) for 1minute	R≧10GΩ
Dielectric Withstand Voltage **Clause 4.7**	Apply the maximum overload voltage (AC) for 1 minute	No breakdown or flashover

PACKAGING

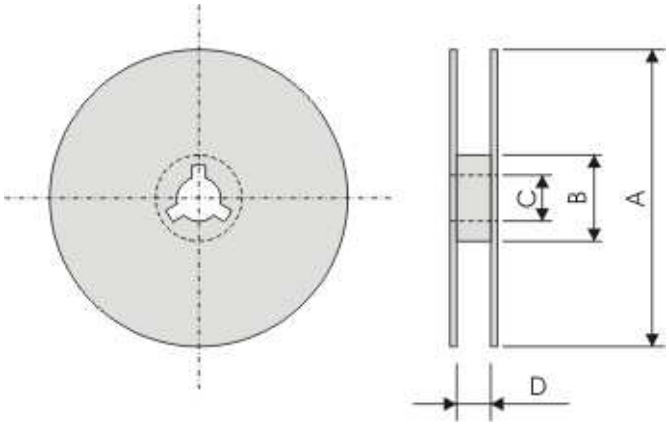
Paper Tape specifications (unit :mm)



Component Size / Series	W	F	E	P0	ΦD
WF10H	8.00±0.30	3.50±0.20	1.75±0.10	4.00±0.10	$\Phi 1.50^{+0.1}_{-0.0}$

Component Size / Series	A	B	P1	T
WF10H	3.60±0.20	3.00±0.20	4.00±0.10	Max. 1.0

Reel dimensions



Symbol	A	B	C	D
(unit : mm)	Φ178.0±2.0	Φ60.0±1.0	13.0±0.2	9.0±0.5

Taping quantity

- Chip resistors 5,000 pcs/reel